PRELIMINARY

SPECIFICATIONS

Customer	天河星
Product Name	Balanced Filter
Sunlord Part Number	SLFBF21-2R450G-A13T
Customer Part Number	

[⊠New Released, ☐Revised]

SPEC No.: SLFBF190004

This SPEC is total 8 pages including specifications and appendix. [ROHS Compliant Parts]

Approved By	Checked By	Issued By
擊德	高譜	門。

Shenzhen Sunlord Electronics Co., Ltd.

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[For Customer app	[For Customer approval Only]		Date:	
Qualification Status:	Full	Restricted	Rejected	
Approved By	Verified By	Re-checked By	Checked By	
Comments:				

[Version change history]

Rev.	Effective Date	Changed Contents	Change reasons	Approved By
01	Jul.18,2019	New release	I	Hai Guo

Caution

All products listed in this specification are developed, designed and intended for use in general electronics equipment. The products are not designed or warranted to meet the requirements of the applications listed below, whose performance and/or quality require especially high reliability, or whose failure, malfunction or trouble might directly cause damage to society, person, or property. Please understand that we are not responsible for any damage or liability caused by use of the products in any of the applications below. Please contact us for more details if you intend to use our products in the following applications.

- 1. Aircraft equipment
- 2. Aerospace equipment
- 3. Undersea equipment
- 4. nuclear control equipment
- 5. military equipment
- 6. Power plant equipment
- 7. Medical equipment
- 8. Transportation equipment (automobiles, trains, ships,etc.)
- 9. Traffic signal equipment
- 10. Disaster prevention / crime prevention equipment
- 11. Data-processing equipment
- 12. Applications of similar complexity or with reliability requirements comparable to the applications listed in the above

1. Scope

This specification applies to SLFBF21-2R450G-A13T of Balanced Filter.

2. Product Description and Identification (Part Number)

1) Description:

Multi-layer Chip Balanced Filter

2) Product Identification (Part Number)

<u>SLFBF</u>	<u>21</u>	-2R450G	- <u>A13</u>	<u>T</u>
1	2	3	4	(5)

1)	Туре
SLFBF	Balanced Filter

3	Center Frequency
2R450G	2450.0 MHz

(5)	Packing
Т	Tape Carrier Package

$\ \ \ \ $ External Dimensions (L \times W) (mm)	
21	2.0 × 1.2

4	Series Code	
	A13	

3. Electrical Characteristics

Part Number	SLFBF-212R450G-A13T	
Unbalance Port Impendance	50 ohm	
Balance Port Impendance	Conjugate match to MTK 5931	
Frequency Range(BW)	2450.0±50.0 MHz	
Incortion Logo in DW	2.5 dB max. at 25 $^{\circ}\mathrm{C}$	
Insertion Loss in BW	2.6 dB max. at -40 to +85 $^{\circ}\mathrm{C}$	
	35.0 dB min at 880.00~960.00MHz	
	30.0 dB min at 1710.00~1880.00MHz	
Attenuation(Absolute value)	20.0 dB min at 1880.00~1990.00MHz	
	25.0 dB min at 4850.00~4900.00MHz	
	25.0 dB min at 7200.00~7500.00MHz	
Unbalance Port V.S.W.R in BW	2.00 max.	
Balance Port V.S.W.R in BW	2.00 max.	
Amplitude balance	1.0 dB max	
Phase differential	180±10 Deg.	
Power Capacity	500 mW max.	

- b) Storage temperature range (packaging conditions): -10 $^{\circ}$ C $^{\sim}$ +40 $^{\circ}$ C and RH 70% (Max.).
- c) Test equipment: Network Analyzer:E5071C.
- d) Electrical Performance: See Fig. 3-1

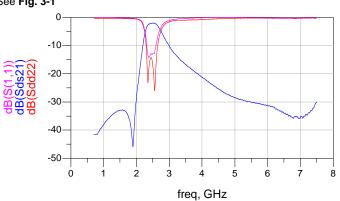
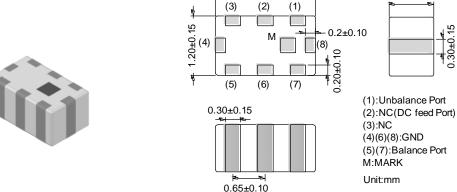


Fig. 3-1

 0.90 ± 0.10

4. Shape and Dimensions

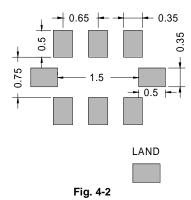
1) Dimensions and terminal configuration: See Fig. 4-1



- 2.00±0.15

Fig. 4-1

2) Recommended Land Pattern: See Fig.4-2



5. Test and Measurement Procedures

5.1 Test Conditions

Unless otherwise specified, the standard atmospheric conditions for measurement/test as:

a. Ambient Temperature: 20±15℃

b. Relative Humidity: 65±20%

c. Air Pressure: 86 KPa to 106 KPa

If any doubt on the results, measurements/tests should be made within the following limits:

a. Ambient Temperature: 20±2°C

b. Relative Humidity: 65±5%

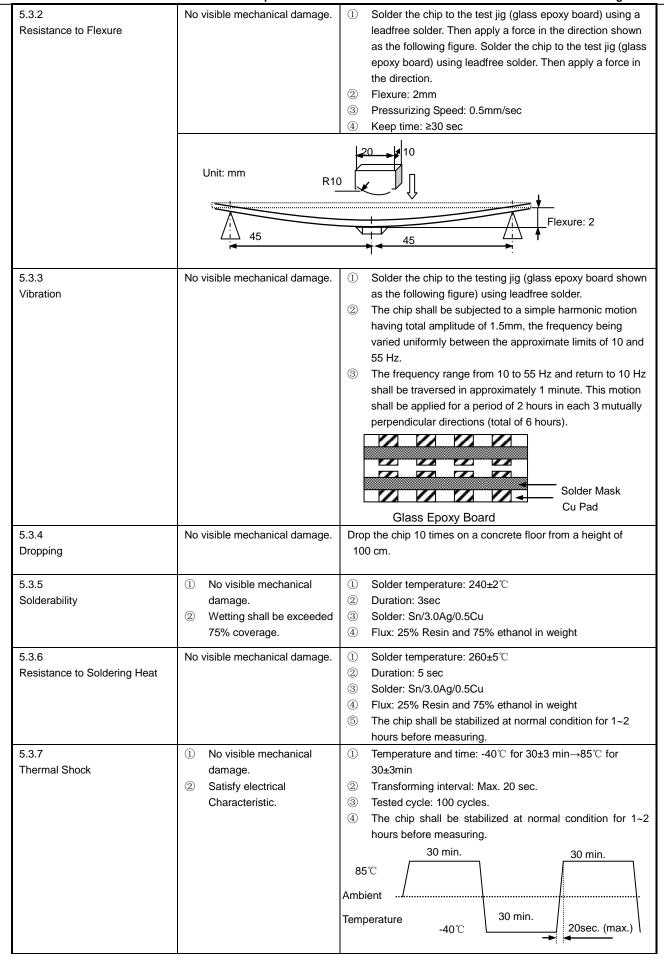
c. Air Pressure: 86KPa to 106 KPa

5.2 Visual Examination

a. Inspection Equipment: 20 X magnifier

5.3 Reliability Test

Items	Requirements	Test Methods and Remarks
5.3.1 Terminal Strength	No visible mechanical damage.	 Solder the inductor to the testing jig (glass epoxy board shown as the following figure) using leadfree solder. Then apply a force in the direction of the arrow. 10N force for 2012 series. Keep time: 10±1sec. Chip 10N/10±1s Speed: 1.0mm/s Glass Epoxy Board



5.3.8	1	No visible mechanical	1	Temperature: 60±2°C		
Damp Heat		damage.	2	Humidity: 90% to 95% RH		
(Steady States)	2	Satisfy electrical	3	③ Duration: 500 ⁺²⁴ hours.		
		Characteristic.	4 The chip shall be stabilized at normal condition for 1~			
				hours before measuring.		
5.3.9	1	No visible mechanical	1	Temperature: 85±2°C		
Resistance to High temperature		damage.	2	Duration: 500 ⁺²⁴ hours.		
	2	Satisfy electrical	3	The chip shall be stabilized at normal condition for 1~2		
		Characteristic.		hours before measuring.		

6. Packaging and Storage

6.1 Packaging

There is one type of packaging for the Balanced Filters. Please specify the packing code when ordering.

6.1.1 Tape Carrier Packaging:

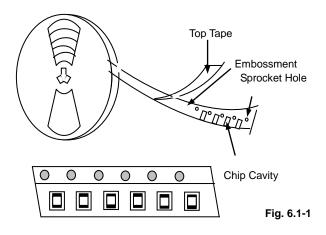
Packaging code: T

- a. Tape carrier packaging are specified in attached figure Fig. 6.1-1~3
- b. Tape carrier packaging quantity please see the following table:

Туре	2012[0805]				
Tape	Embossed Tape				
Quantity	4K				

(1) Taping Drawings (Unit: mm)

Embossed Tape



Remark: The sprocket holes are to the right as the tape is pulled toward the user.

(2) Taping Dimensions (Unit: mm)

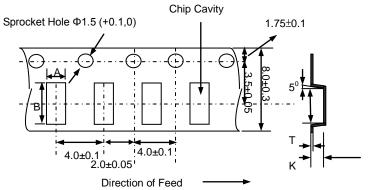


Fig. 6.1-2

Т	уре	Chip Thickness	А	В	K max	T max
SLI	FBF21	0.90±0.10	1.42±0.10	2.25±0.10	1.14	0.27

Reel Dimensions (Unit: mm) 8.4+1.5/-0.0mm 5.0±0.1mm 3.0±0.1mm max < 14.4mm

178±2.0mm Fig. 6.1.3 6.2 Storage

- a. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to high humidity. Package must be stored at 40°C or less and 70% RH or less.
- b. The solderability of the external electrode may be deteriorated if packages are stored where they are exposed to dust of harmful gas (e.g. HCl, sulfurous gas of H₂S).
- c. Packaging material may be deformed if package are stored where they are exposed to heat of direct sunlight.
- d. Solderability specified in **Clause 5.3.6** shall be guaranteed for 6 months from the date of delivery on condition that they are stored at the environment specified in **Clause 3**. For those parts, which passed more than 6 months shall be checked solder-ability before use.

7. Recommended Soldering Technologies

7.1 Reflow Profile

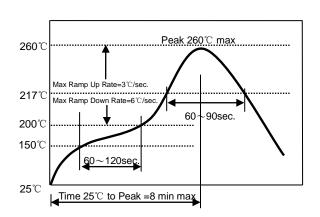
△ Preheat condition: 150 ~200°C/60~120sec.

 \triangle Allowed time above 217°C: 60~90sec.

△ Max temp: 260°C

△ Max time at max temp: 10sec.
 △ Solder paste: Sn/3.0Ag/0.5Cu
 △ Allowed Reflow time: 2x max

[Note: The reflow profile in the above table is only for qualification and is not meant to specify board assembly profiles. Actual board assembly profiles must be based on the customer's specific board design, solder paste and process, and should not exceed the parameters as the Reflow profile shows.]

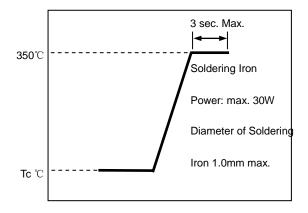


7.2 Iron Soldering Profile

△ Iron soldering power: Max.30W

△ Soldering Tip temperature: 350°C Max.

[Note: Take care not to apply the tip of the soldering iron to the terminal electrodes.]



8. Supplier Information

a) Supplier:

Shenzhen Sunlord Electronics Co., Ltd.

b) Manufacturer:

Shenzhen Sunlord Electronics Co., Ltd.

c) Manufacturing Address:

Sunlord Industrial Park, Dafuyuan Industrial Zone, Guanlan, Shenzhen, China

Zip: 518110

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